

**In The United States Patent and Trademark Office  
On Appeal from the Examiner to the Board  
of Patent Appeals and Interferences**

In re Application of: Albert (nmi) Chan  
Serial No.: 10/663,207  
Filing Date: September 15, 2003  
Group Art Unit: 1733  
Confirmation No.: 2364  
Examiner: John L. Goff II  
Title: Thermal Interface Adhesive

**Mail Stop: Appeal Brief - Patents**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Dear Sir:

**REQUEST FOR STATUS**

Please advise of the status of the above-identified patent application. A Reply Brief in response to the Examiner's Answer mailed December 13, 2007 was filed by Appellant on January 2, 2008. Appellant is currently awaiting a decision from the Board of Patent Appeals and Interferences.

If there are any matters that can be resolved through a telephone conference, please contact the undersigned attorney for Appellant at the telephone number listed below.

Respectfully submitted,

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Brian W. Oaks  
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Date: April 17, 2008

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